

## STTH8L06

## Turbo 2 ultrafast high voltage rectifier

#### **Features**

- Ultrafast switching
- Low reverse recovery current
- Low thermal resistance
- Reduces switching and conduction losses
- Package insulation voltage:

TO-220AC Ins: 2500 V rmsTO-220FPAC: 2000 V DC

#### **Description**

The STTH8L06, which is using ST Turbo2 600 V technology, is specially suited as boost diode in discontinuous or critical mode power factor corrections.

The device is also intended for use as a free wheeling diode in power supplies and other power switching applications.

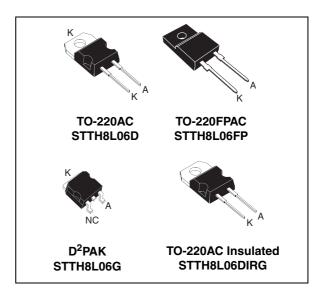


Table 1. Device summary

Symbol	Value
I <sub>F(AV)</sub>	8 A
V <sub>RRM</sub>	600 V
I <sub>R</sub> (max)	200 μΑ
T <sub>j</sub>	175 °C
V <sub>F</sub> (typ)	0.85 V
t <sub>rr</sub> (typ)	75 ns

Characteristics STTH8L06

### 1 Characteristics

Table 2. Absolute ratings (limiting values)

Symbol		Value	Unit		
$V_{RRM}$	Repetitive peak reverse voltage			600	V
1	Forward rms current TO-220AC / TO-220FPAC / D <sup>2</sup> PAK		30	Α	
I <sub>F(RMS)</sub>   Forward rms current		TO-220AC Ins.		24	^
	$I_{F(AV)}$ Average forward current $\delta = 0.5$	TO-220AC / D <sup>2</sup> PAK	T <sub>c</sub> = 150 °C		
I <sub>F(AV)</sub>		TO-220FPAC	T <sub>c</sub> = 125 °C	8	Α
	0 - 0.0	TO-220AC Ins.	T <sub>c</sub> = 135 °C		
I <sub>FSM</sub>	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$				Α
T <sub>stg</sub>	Storage temperature range				°C
T <sub>j</sub>	Operating junction temperation	-40 to 175	°C		

Table 3. Thermal resistance

Symbol	Param	Value (max)	Unit	
		TO-220AC / D <sup>2</sup> PAK	2.5	
R <sub>th(j-c)</sub>	Junction to case	TO-220FPAC	5	°C/W
		TO-220AC Ins.	4	

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
,	Payaraa laakaga aurrant	T <sub>j</sub> = 25 °C	$V_R = V_{RRM}$			8	μA
'R	I <sub>R</sub> Reverse leakage current	T <sub>j</sub> = 150 °C			16	200	μΑ
V <sub>F</sub>	Forward voltage drop	T <sub>j</sub> = 25 °C	I - 0 A			1.3	V
V <sub>F</sub> Forward voltage drop	T <sub>j</sub> = 150 °C	I <sub>F</sub> = 8 A		0.85	1.05	V	

To evaluate the conduction losses use the following equation:  $P = 0.89 \text{ x } I_{F(AV)} + 0.022 I_{F^2(RMS)}$ 

Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
t <sub>rr</sub>	Reverse recovery time	T <sub>j</sub> = 25 °C	$I_F = 1 \text{ A}, dI_F/dt = -50 \text{ A/}\mu\text{s V}_R = 30 \text{ V}$		75	105	ns
I <sub>RM</sub>	Reverse recovery current	T <sub>j</sub> = 125 °C	$I_F = 8 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}, \ V_R = 400 \text{ V}$		7.2	10	Α
t <sub>fr</sub>	Forward recovery time	T 05°C	$I_F = 8 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}$ $V_{FR} = 1.1 \text{ x } V_{Fmax}$			150	ns
V <sub>FP</sub>	Forward recovery voltage	T <sub>j</sub> = 25°C	$I_F = 8 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}$			6	V

STTH8L06 Characteristics

Figure 1. Conduction losses versus average current

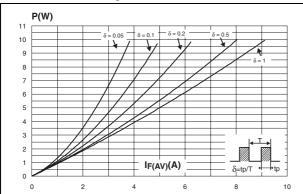


Figure 2. Forward voltage drop versus forward current

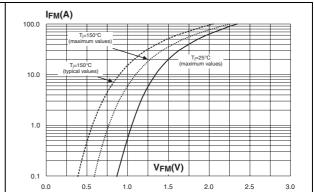


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration (TO-220FPAC)

 $Z_{th(j-c)}/R_{th(j-c)}$ 1.0 0.9 0.8 0.7 0.6 0.5 0.4 0.3 0.2 0.0 1.E-03 1.E-02 1.E-01 1.E+00 1.E+01

Figure 4. Relative variation of thermal impedance junction to case versus pulse duration

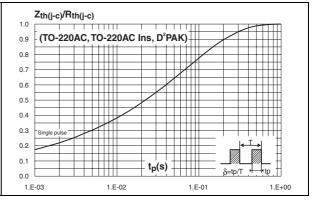


Figure 5. Peak reverse recovery current versus dl<sub>F</sub>/dt (typical values)

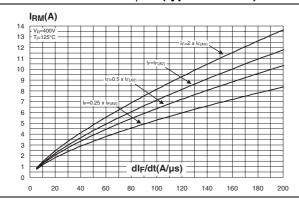
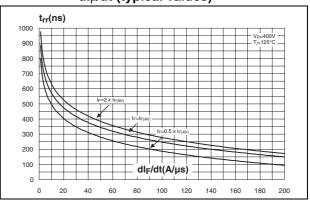
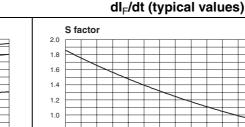


Figure 6. Reverse recovery time versus dl<sub>F</sub>/dt (typical values)



**Characteristics** STTH8L06

Figure 7. Reverse recovery charges versus dl<sub>F</sub>/dt (typical values)



0.6

0.4

0.2

0.0

Figure 8.

Q<sub>rr</sub>(nC) 1000 900 800 700 600 500 400 300 200 100 dlf/dt(A/µs) 0 0 40

0.8

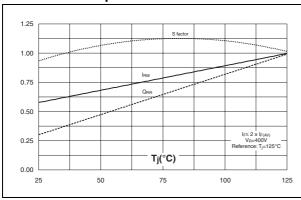
dlf/dt(A/µs)

150

Softness factor versus

Figure 9. Relative variations of dynamic parameters versus junction temperature

Figure 10. Transient peak forward voltage versus dl<sub>F</sub>/dt (typical values)



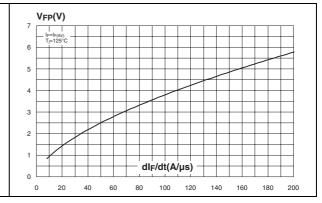
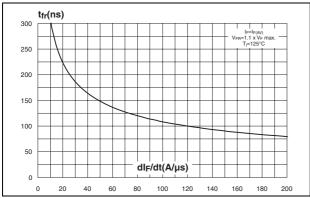
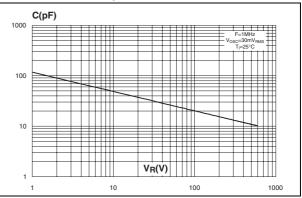


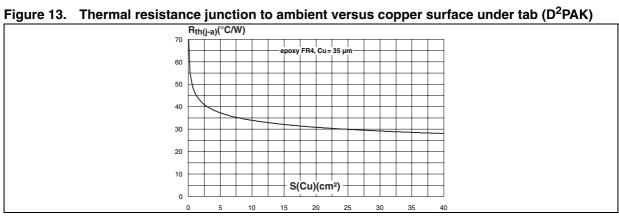
Figure 11. Forward recovery time versus dl<sub>F</sub>/dt (typical values)

Figure 12. Junction capacitance versus reverse voltage applied (typical values)





STTH8L06 **Characteristics** 



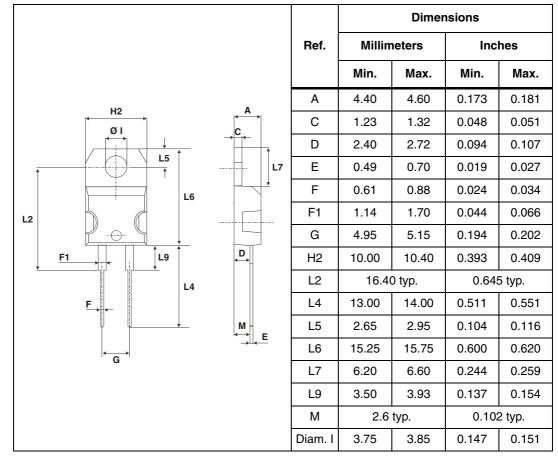
Package information STTH8L06

### 2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.4 N·m to 0.6 N·m

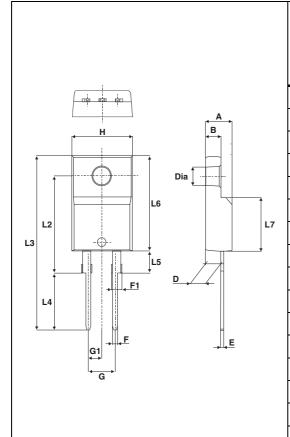
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Table 6. TO-220AC dimensions



STTH8L06 Package information

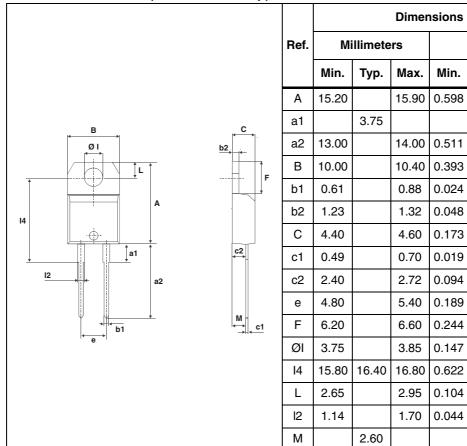
Table 7. TO-220FPAC dimensions



	Dimensions				
Ref.	Millimeters		Inc	nes	
	Min.	Min. Max.		Max.	
Α	4.4	4.6	0.173	0.181	
В	2.5	2.7	0.098	0.106	
D	2.5	2.75	0.098	0.108	
Е	0.45	0.70	0.018	0.027	
F	0.75	1	0.030	0.039	
F1	1.15	1.70	0.045	0.067	
G	4.95	5.20	0.195	0.205	
G1	2.4	2.7	0.094	0.106	
Н	10	10.4	0.393	0.409	
L2	16	Гур.	0.63 Typ.		
L3	28.6	30.6	1.126	1.205	
L4	9.8	10.6	0.386	0.417	
L5	2.9	3.6	0.114	0.142	
L6	15.9	16.4	0.626	0.646	
L7	9.00	9.30	0.354	0.366	
Dia.	3.00	3.20	0.118	0.126	

Package information STTH8L06

Table 8. TO-220AC (Nins. & Ins. 20-up) dimensions



Inches

Тур.

0.147

Max.

0.625

0.551

0.409

0.034

0.181

0.027

0.107

0.212

0.259

0.151

0.116

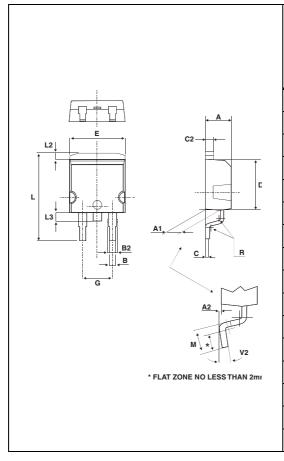
0.066

0.646

0.102

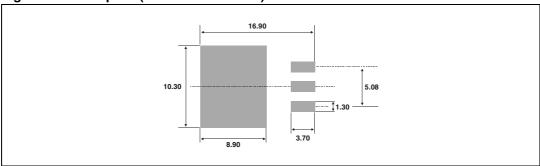
STTH8L06 Package information

Table 9. D<sup>2</sup>PAK dimensions



	Dimensions					
Ref.	Millim	Millimeters		hes		
	Min.	Max.	Min.	Max.		
Α	4.40	4.60	0.173	0.181		
A1	2.49	2.69	0.098	0.106		
A2	0.03	0.23	0.001	0.009		
В	0.70	0.93	0.027	0.037		
B2	1.14	1.70	0.045	0.067		
С	0.45	0.60	0.017	0.024		
C2	1.23	1.36	0.048	0.054		
D	8.95	9.35	0.352	0.368		
Е	10.00	10.40	0.393	0.409		
G	4.88	5.28	0.192	0.208		
L	15.00	15.85	0.590	0.624		
L2	1.27	1.40	0.050	0.055		
L3	1.40	1.75	0.055	0.069		
М	2.40	3.20	0.094	0.126		
R	0.40 typ.		0.016	6 typ.		
V2	0°	8°	0°	8°		

Figure 14. Footprint (dimensions in mm)



Ordering information STTH8L06

# **3** Ordering information

Table 10. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH8L06D	STTH8L06D	TO-220AC	1.90 g	50	Tube
STTH8L06G	STTH8L06G	D <sup>2</sup> PAK	1.48 g	50	Tube
STTH8L066G-TR	STTH8L06G	D <sup>2</sup> PAK	1.48 g	1000	Tape and reel
STTH8L06FP	STTH8L06FP	TO-220FPAC	1.70 g	50	Tube
STTH8L06DIRG	STTH8L06DI	TO-220AC Ins.	1.86 g	50	Tube

## 4 Revision history

Table 11. Document revision history

Date	Revision	evision Changes	
Nov-2002	2A	Last issue	
18-Oct-2004	3	TO-220AC Insulated and D <sup>2</sup> PAK packages added	
13-Jun-2005	4	T <sub>j</sub> changed from value 175 to range -40 to 175 °C - Page1	
10-Aug-2006	5	Reformatted to current standard. Added package insulation voltage data on page 1. Changed order code STTH8L06DI to STTH8L06DIRG.	
07-Feb-2012	6	Added I <sub>RM</sub> to <i>Table 4</i> .	

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